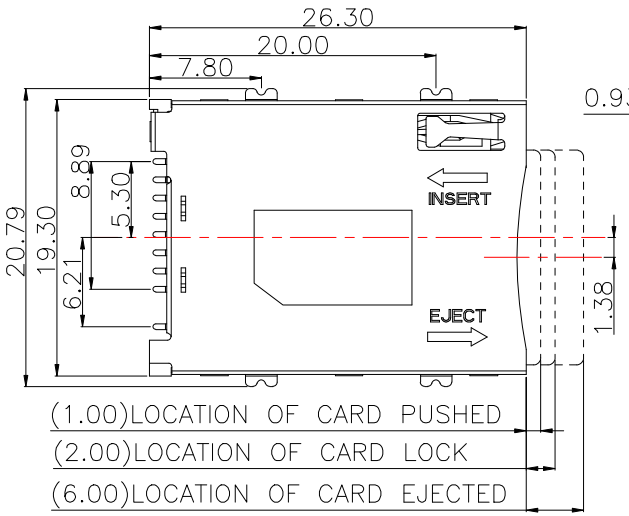
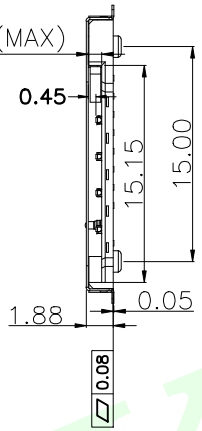
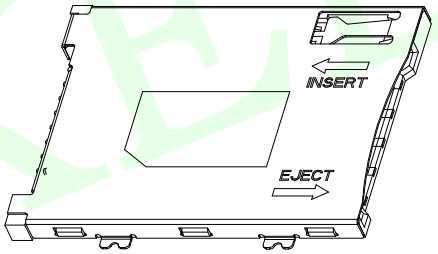
RoHS Compliant

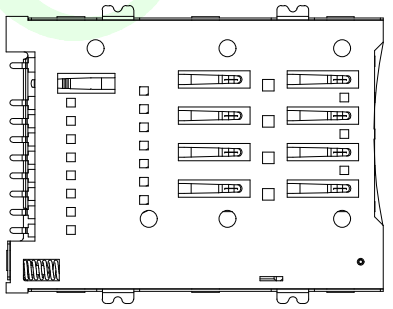
NOTES:
1.MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0,COLOR:BLACK.
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
2.PLATING:
UNDERPLATE: NICKEL.
CONTACT AREA: GOLD OVER NICKEL.
SOLDER AREA: TIN OVER NICKEL.
3.MULTIMEDIA CARD COMPATIBLE

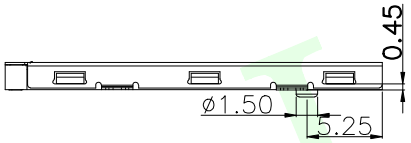


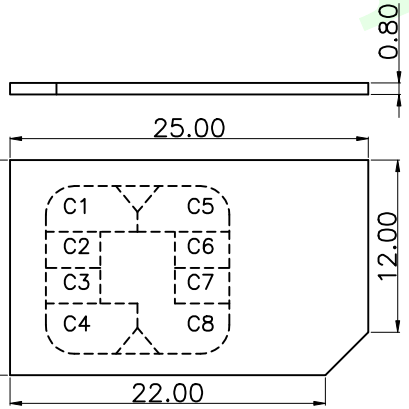


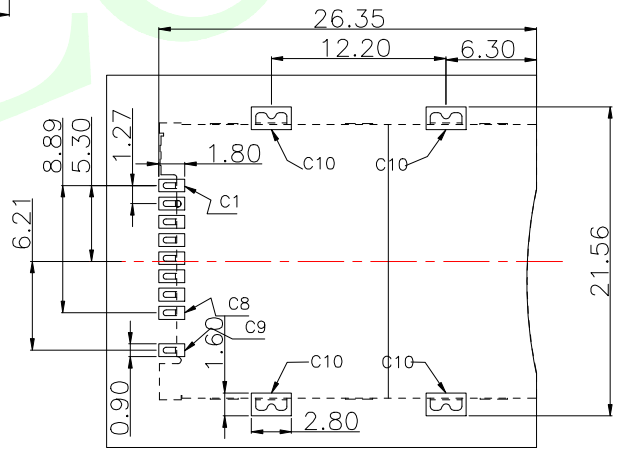
MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	GND OF SIM
C3	RST OF SIM
C4	VPP OF SIM
C5	CLK OF SIM
C6	I/O OF SIM
C7	DATO OF SIM
C8	MCMD OF SIM
C9	CARD DETECT SWITCH
C10	GND OF SIM











RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

LCK-MS-209H190 09-W LG

连晟欣 LCK
产品类别
MS:MINI SIM
SIM:MICRO SIM
NANO：NANO SIM
产品流水料号识别码
产品高度
H190：1.90MM
有柱无柱
Y：有柱
W：无柱
产品PIN位
09：9PIN
包装方式
L：圆盘
电镀规格
G：gold flash
G1：1U
G3：3U
（以此推类）

MEASURE POINT:
QUADRANT POINT (QP)
TANGERCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE SPECIFIED,TOLERANCE:

X.	±0.25
X.x	±0.20
X.xx	±0.15
ANGULAR	±3°

联晟欣连接器（深圳）有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24
CHECKED		DATE	
APPROVED		DATE	

TITLE: MINI SIM CARD PUSH PUSH 8+1P SMT 无住 1.9H

PART NO: LCK-MS-209H19009-WLG	REV: 04	SCALE: 1:1	UNIT: mm
DRAWING NO: 102022214	SIZE: A4	SHEET: 1/1	

LCKELEC